



Materials Declaration Form

IPC	1752	Version	2
Form Type *	Distribute		
Sectionals *	Material Info Manufacturing Info	Subsectionals *	A-D * : Required Field

Supplier Information			
Company Name *	STMicroelectronics	Response Date *	2020-06-05
Company Unique ID	NL 008751171B01		
Contact Name *	Refer to Supplier Comment section		Refer to Supplier Comment section
Contact Phone *	Refer to Supplier Comment section	Contact Email *	Refer to Supplier Comment section
Authorized Representative *	Floriana SAN BIAGIO	Representative Title	AMS MD CHAMPION
Representative Phone *	Refer to Supplier Comment section	Representative Email *	Refer to Supplier Comment section
Supplier Comment	Online Technical Support - STMicroelectronics : http://www.st.com/web/en/support/support.html		

Uncertainty Statement

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Legal Statement

Supplier Acceptance *	true	Legal Declaration *	Standard
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Legal Statement

Supplier certifies that it gathered the provided information and such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part(s), and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part(s), the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.

Product				
Mfr Item Number	Mfr Item Name	Version	Mfr Site	Date
	HYWO*V315161	A	9992	2020-06-05
	Amount	UoM	Unit type	ST ECOPACK Grade
	7	mg	Each	ECOPACK* 3
Comment	ECOPACK® 3 is STMicroelectronics trade name for ROHS compliant device without use of any ROHS exemption and without Halogen nor Antimony			

Manufacturing information				
J-STD-020 MSL Rating	Classification Temp	Nbr of Reflow Cycles		 life.augmented
1	260	3		
Bulk Solder Termination	Terminal Plating	Terminal Base Alloy	Comment	
Not Applicable	Nickel/Palladium/Gold (Ni/Pd/Au)	Copper Alloy		

Package Designator	Package Size	Nbr of instances	Shape	
DSO	2 x 1.26	6	Gull wing	
Comment	WO SOT 323 6LDS; MDF is valid for STG3157CTR			

QueryList : RoHS Directive 2011/65/EU-July 2011 Annex II amended by Directive 2015/863-March 2015	
Query	Response
1 - Product(s) meets EU RoHS requirement without any exemptions	true
2 - Product(s) meets EU RoHS requirements except lead in solder and this usage may qualify under the lead in solder '7b' exemption (other selected exemptions may apply)	false
3 - Product(s) meets EU RoHS requirements by application of the selected exemption(s)	false
4 - Product(s) does not meet EU RoHS requirements and is not under exemptions	false
Exemption Id.	Description

QueryList : ELV directive : 2000/53/EC amended 2020/363_March 2020	
Query	Response
1 - Product(s) meets EU ELV requirements without any exemptions	true
2 - Product(s) meets EU RoHS requirements by application of the selected exemption(s)	false
Exemption Id.	Description

QueryList : California Prop65 list, dated 3rd January 2020			
Query			Response
1 - The product does not contain identified substance from California Prop 65 List, no exposure to consumers is foreseen			false
2 - The product is containing below substance(s) from California Prop 65 List, no exposure to consumers is foreseen			true
Substance	amount in product (mg)	Application	ppm in product
Nickel	0.03	alloy&coating	4714

QueryList : REACH-16th January 2020				
Query				Response
1 - Product(s) does not contain REACH Substances Of Very High Concern above the limits per the definition within REACH				true
CategoryLevel_Name	CategoryLevel_Threshold	amount in product (mg)	Application	ppm in product
,				
2 - Product(s) does not contain REACH Substances Of Very High Concern in any Embedded article nor Homogeneous Material above the limits per the definition within REACH				true
CategoryLevel_Name	CategoryLevel_Threshold	Amount in Embedded Article / Homogeneous Material (mg)	Application - Article / Homogeneous Material	ppm in Article /Homogeneous Material
,			,	

QueryList : Korea Chemical Control Act_ 27 Dec 2017 update				
Query				Response
The Product does contain at least one of the substances listed in Chemical Control Act				false
Substance	Homogeneous Material impacted	Content in Homogeneous Material (mg)	Concentration in the material(%)	Application Purpose

Material Composition Declaration : note : Substance present with less 0.001mg will not be declared in this document						Mfr Item Name	HYWO*V315161				4999862.0	986287.0
Homogeneous Material	Material Group	Mass	UoM	Level	Substance Category	Substance	CAS	Exempt	Mass	UoM	Concentration in homogeneous material (ppm)	Concentration in product (ppm)
Die	M-011 Other inorganic materials	0.208	mg	supplier	die	Silicon(Si)	7440-21-3		0.201	mg	966346	28714
				supplier	metallisation	Aluminium(Al)	7429-90-5		0.001	mg	4808	143
				supplier	metallisation	Titanium(Ti)	7440-32-6		0.001	mg	4808	143
				supplier	Passivation	Silicon nitride(SiN)	12033-89-5		0.001	mg	4808	143
				supplier	passivation	Silicon oxide	7631-86-9		0.004	mg	19231	571
Leadframe	M-004 Copper and its alloys	2.880	mg	supplier	alloy & coating	Copper(Cu)	7440-50-8		2.774	mg	963061	396286
				supplier	alloy & coating	Nickel(Ni)	7440-02-0		0.033	mg	11457	4714
				supplier	alloy & coating	Iron(Fe)	7439-89-6		0.065	mg	22566	9286
				supplier	alloy & coating	Phosphorus metal	7723-14-0		0.001	mg	347	143
				supplier	alloy & coating	Zinc(Zn)	7440-66-6		0.004	mg	1389	571
Die attach	M-015 Other organic materials	0.020	mg	supplier	alloy & coating	Palladium(Pd)	7440-05-3		0.003	mg	1042	429
				supplier	glue	Aluminium oxide	1344-28-1		0.006	mg	300000	857
				supplier	glue	Diethylene glycol monoethyl ether acetate	112-15-2		0.008	mg	400000	1143
				supplier	glue	Epoxy resin-1	25068-38-6		0.001	mg	50000	143
				supplier	glue	Epoxy resin-2	Proprietary		0.004	mg	200000	571
Bonding wires	M-008 Precious metals	0.020	mg	supplier	glue	Aromatic amine	Proprietary		0.001	mg	50000	143
				supplier	wire	Gold (Au)	7440-57-5		0.020	mg	1000000	2857
Encapsulation	M-011 Other inorganic materials	3.776	mg	supplier	mold compound	Epoxy Resin-1	29690-82-2		0.086	mg	22775	12286
				supplier	mold compound	Epoxy Resin-2	Proprietary		0.086	mg	22775	12286
				supplier	mold compound	Phenol resin	25068-38-6		0.129	mg	34163	18429
				supplier	mold compound	Silica	60676-86-0		3.411	mg	903337	487286
				supplier	mold compound	Carbon Black	1333-86-4		0.006	mg	1589	857
				supplier	mold compound	Others	Proprietary		0.058	mg	15360	8286